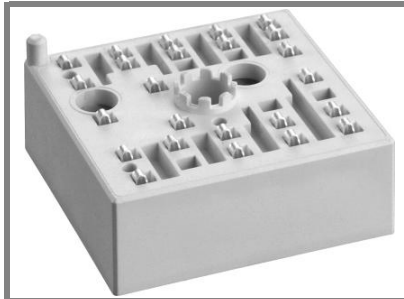


SKiiP 15AC066V1



MiniSKiiP[®] 1

3-phase bridge inverter

SKiiP 15AC066V1

Features

- Trench IGBT's
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

Typical Applications

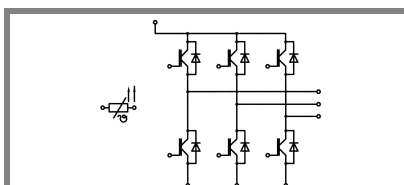
- Inverter up to 10,0 kVA
- Typical motor power 4,0 kW

Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$
- SC data: $t_p \leq 6 \mu\text{s}$; $V_{GE} \leq 15 \text{ V}$; $T_j = 150^\circ\text{C}$; $V_{CC} = 360\text{V}$
- V_{CEsat} , V_F = chip level value

Absolute Maximum Ratings		$T_S = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT - Inverter			
V_{CES}		600	V
I_C	$T_S = 25 (70)^\circ\text{C}, T_j = 150^\circ\text{C}$	39 (27)	A
I_C	$T_S = 25 (70)^\circ\text{C}, T_j = 175^\circ\text{C}$	40 (32)	A
I_{CRM}	$t_p = 1 \text{ ms}$	60	A
V_{GES}		± 20	V
T_j		-40 ... +175	$^\circ\text{C}$
Diode - Inverter			
I_F	$T_S = 25 (70)^\circ\text{C}, T_j = 150^\circ\text{C}$	33 (22)	A
I_F	$T_S = 25 (70)^\circ\text{C}, T_j = 175^\circ\text{C}$	39 (29)	A
I_{FRM}	$t_p = 1 \text{ ms}$	60	A
T_j		-40 ... +175	$^\circ\text{C}$
I_{RMS}	per power terminal (20 A / spring)	40	A
T_{stg}	$T_{op} \leq T_{stg}$	-40 ... +125	$^\circ\text{C}$
V_{isol}	AC, 1 min.	2500	V

Characteristics		$T_S = 25^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT - Inverter					
V_{CEsat}	$I_{Cnom} = 30 \text{ A}, T_j = 25 (150)^\circ\text{C}$	1	1,45 (1,65)	1,9 (2,1)	V
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 0,5 \text{ mA}$		5,8		V
$V_{CE(TO)}$	$T_j = 25 (150)^\circ\text{C}$		0,9 (0,85)	1 (0,9)	V
r_T	$T_j = 25 (150)^\circ\text{C}$		20 (28)	30 (40)	m Ω
C_{ies}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		1,6		nF
C_{oes}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		0,19		nF
C_{res}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$		0,17		nF
$R_{CC+EE'}$	spring contact-chip $T_s = ()^\circ\text{C}$				m Ω
$R_{th(j-s)}$	per IGBT		1,35		K/W
$t_{d(on)}$	under following conditions		20		ns
t_r	$V_{CC} = 300 \text{ V}, V_{GE} = -8\text{V}/+15\text{V}$		20		ns
$t_{d(off)}$	$I_{Cnom} = 30 \text{ A}, T_j = 150^\circ\text{C}$		200		ns
t_f	$R_{Gon} = R_{Goff} = 12 \Omega$		50		ns
$E_{on}(E_{off})$	inductive load		1 (1,1)		mJ
Diode - Inverter					
$V_F = V_{EC}$	$I_{Fnom} = 30 \text{ A}, T_j = 25 (150)^\circ\text{C}$		1,5 (1,5)	1,7 (1,7)	V
$V_{(TO)}$	$T_j = 25 (150)^\circ\text{C}$		1 (0,9)	1,1 (1)	V
r_T	$T_j = 25 (150)^\circ\text{C}$		16,7 (20)	20 (23,3)	m Ω
$R_{th(j-s)}$	per diode		2,1		K/W
I_{RRM}	under following conditions		54,4		A
Q_{rr}	$I_{Fnom} = 30 \text{ A}, V_R = 300 \text{ V}$		4		μC
E_{rr}	$V_{GE} = 0 \text{ V}, T_j = 150^\circ\text{C}$		1,1		mJ
	$di_F/dt = 2150 \text{ A}/\mu\text{s}$				
Temperature Sensor					
R_{ts}	3 %, $T_r = 25 (100)^\circ\text{C}$		1000(1670)		Ω
Mechanical Data					
m			35		g
M_s	Mounting torque	2		2,5	Nm



AC

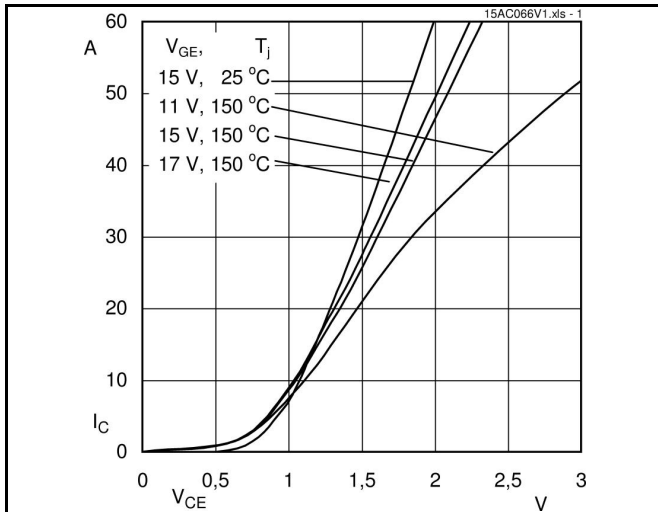


Fig. 1 Output characteristic

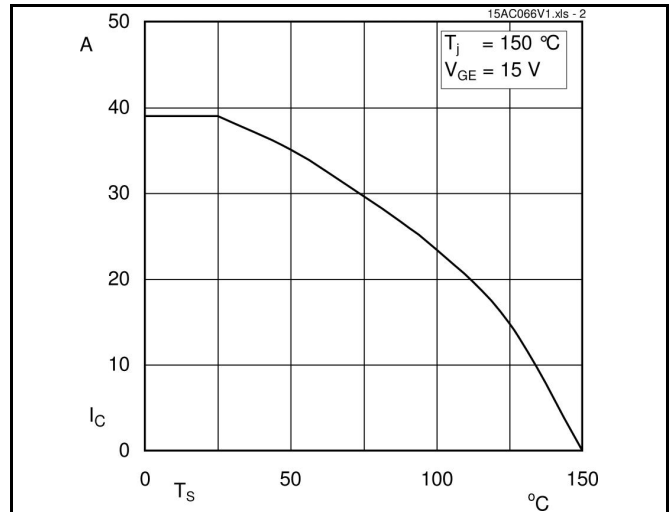


Fig. 2 Rated current vs. temperature

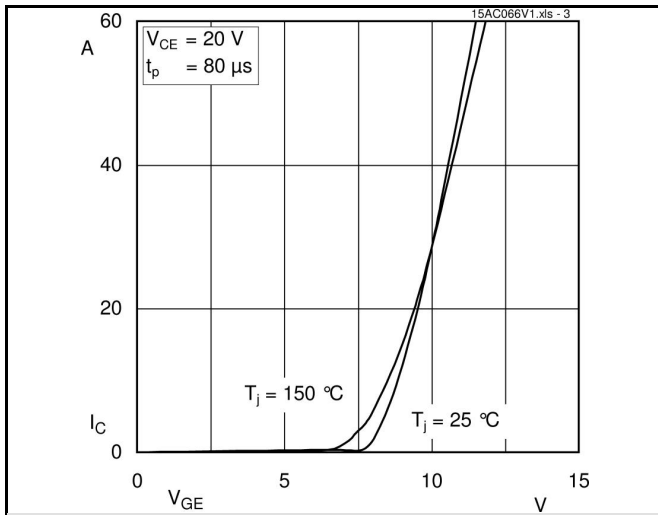


Fig. 3 Typ. transfer characteristic

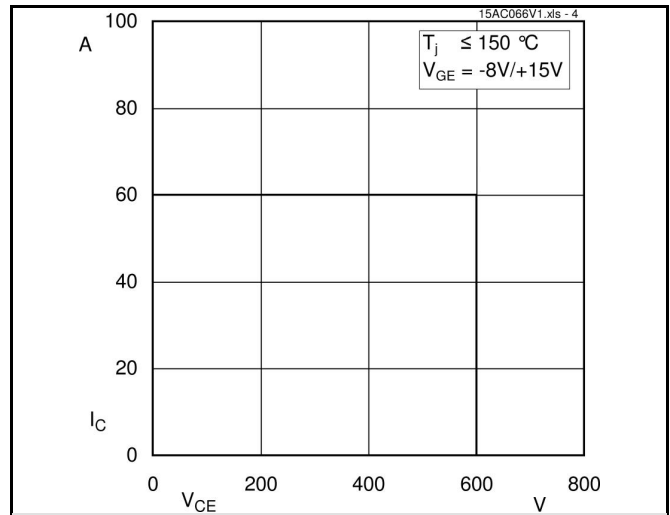


Fig. 4 Reverse bias safe operating area

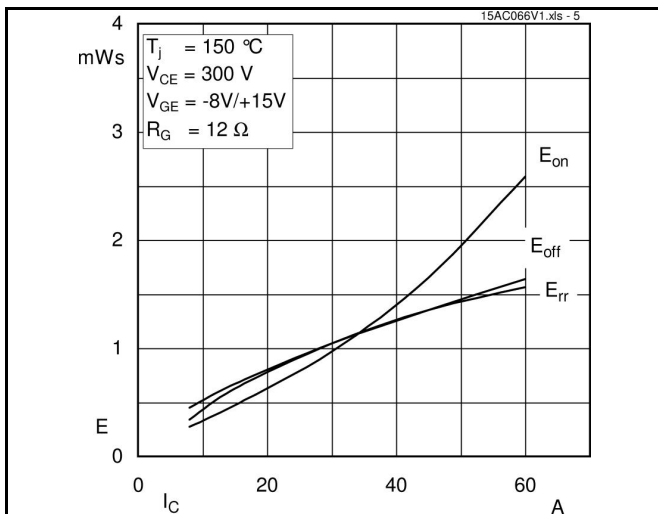


Fig. 5 Typ. Turn-on /-off energy = $f(I_C)$

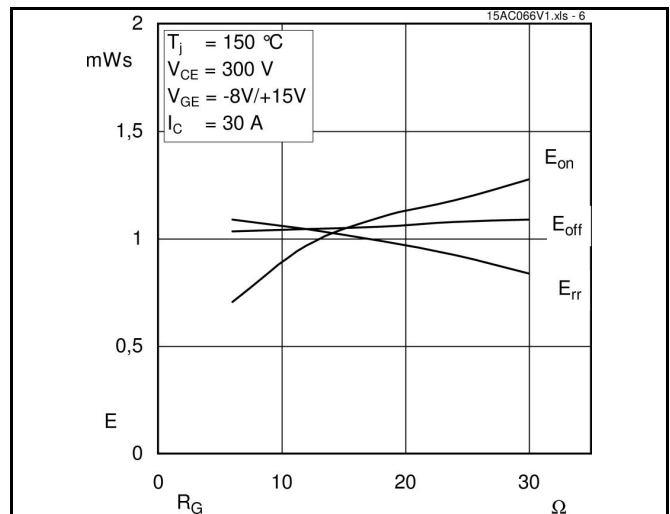


Fig. 6 Turn-on /-off energy = $f(R_G)$

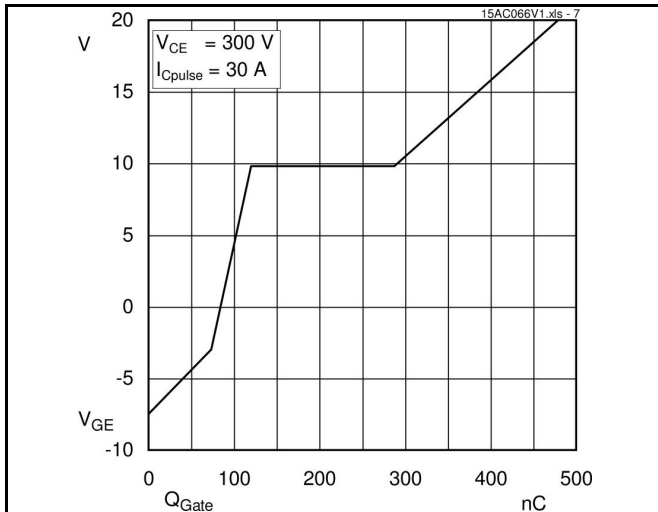


Fig. 7 Typ. gate charge characteristic

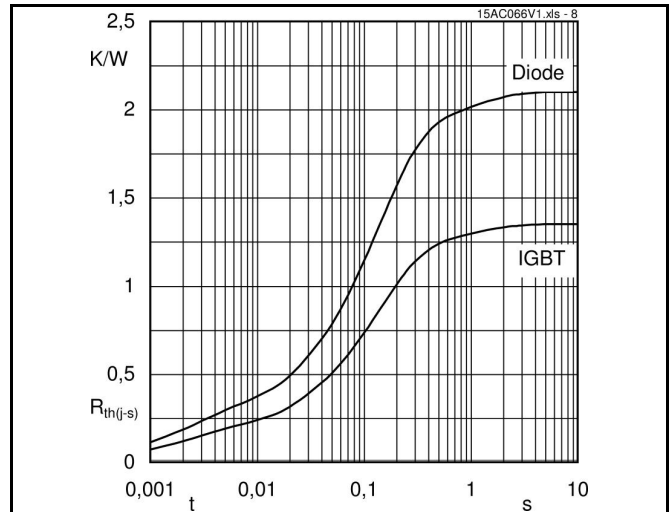


Fig. 8 Typ. Thermal impedance

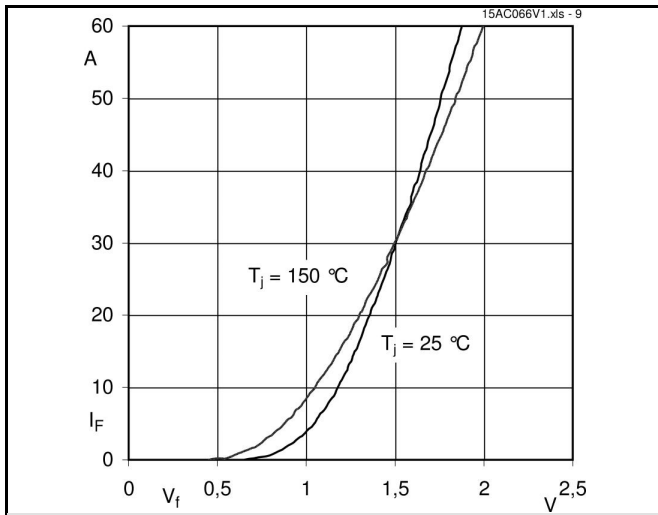
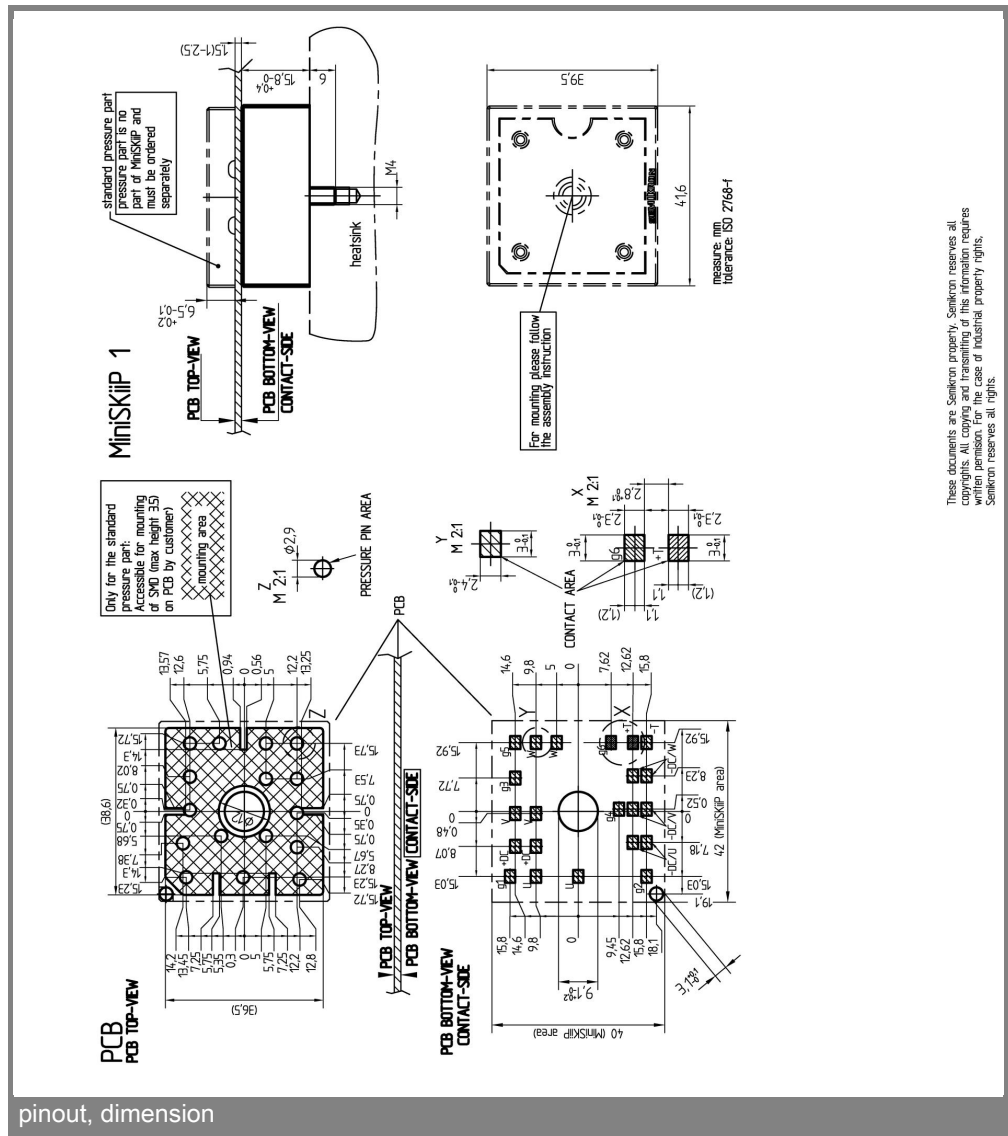
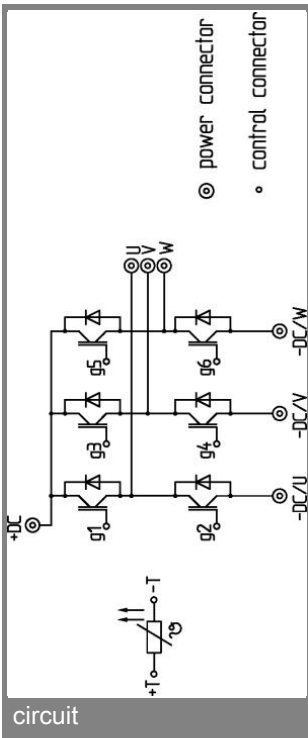


Fig. 9 Typ. freewheeling diode forward characteristic



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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